

The evolution of Wireless Communication is shaking up Test And Measurement!

Marc Vanden Bossche

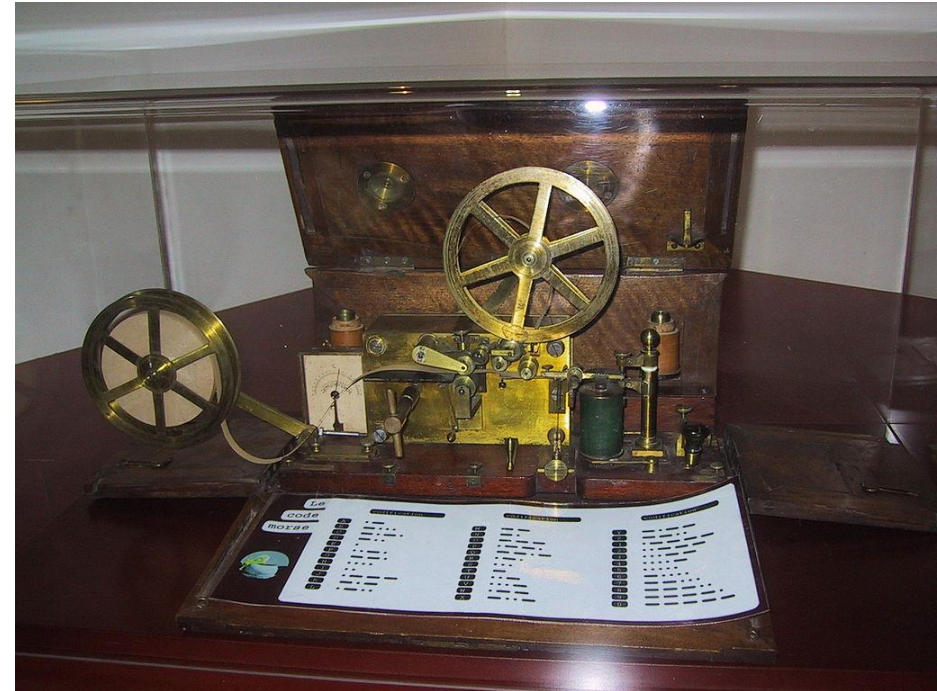
Contact: Marc.Vanden.Bossche@ni.com

ni Evolution of Telecommunication

The first wired, electrical commercial communications



5 Needle telegraph (1837)
Cooke and Wheatstone (British) (*)



Morse telegraph (1837)
Samuel Morse (American) (**)

(*): By Geni - Photo by User:geni, CC BY-SA 4.0, <https://commons.wikimedia.org/w/index.php?curid=6503269>

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ni Evolution of Telecommunication



Source: Ericsson



27%

2016
Smartphone
Penetration
Rate

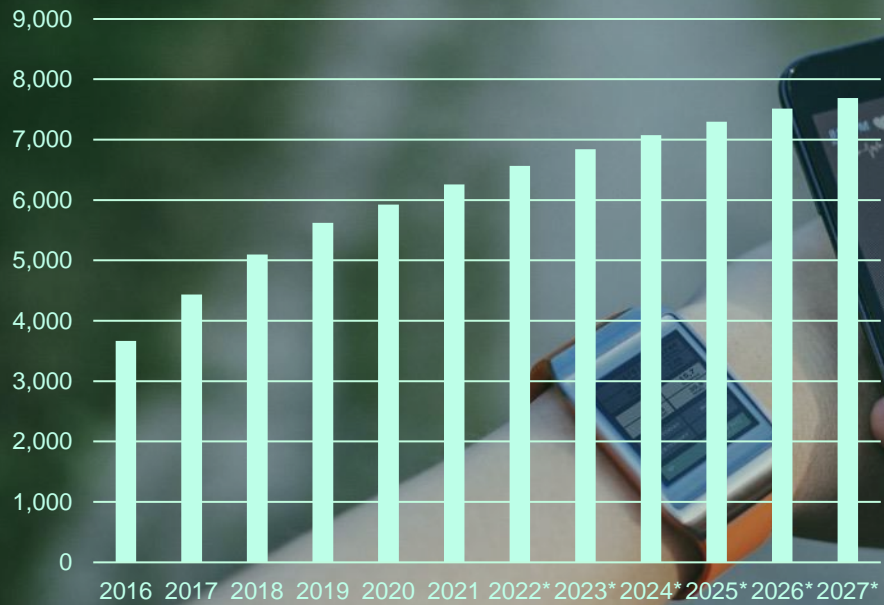
78%

2020
Smartphone
Penetration
Rate

87%

2025
Smartphone
Penetration
Rate

Worldwide Smartphone Subscriptions



Source: Ericsson

Smart Phone Unit Sales



Source: Gartner



Wireless Adoption Will Continue to Grow

6%

FORECASTED WIRELESS IC REVENUE CAGR
FROM \$23B (2022) TO \$32B (2027)

4X

PROJECTED INCREASE OF MOBILE
TRAFFIC DATA BY 2027

51%

OF ALL CELLULAR CONNECTIONS
BY 2027 WILL BE MASSIVE IoT

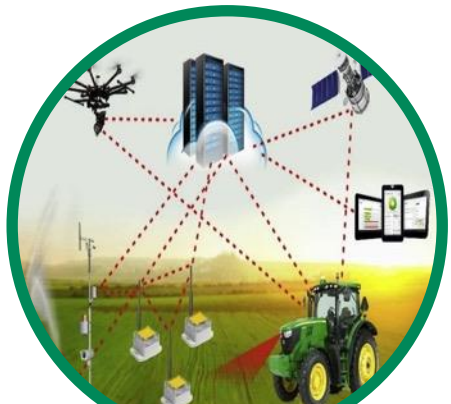


ni Shift to IoT Applications



Human-Centric Wireless Systems

- **Inputs & outputs** are human-centric (audio, video, tactile)
- Traditional **CPU-based software** (augmented with ML)
- **Latency** requirements are human-centric (100's of ms)
- Systems mimic their **centricity** - designed for 1-1 connections



Machine-Centric Wireless Systems

- **Inputs & outputs** are machine-centric (radar, lidar, cameras, motors)
- **ML-based neural nets** play a much larger role
- **Latency** requirements are machine-centric (μ s or better)
- Systems mimic their **centricity** - designed for machines to collaboratively perform a task

“A decade ago, we had about 24 months from engineering sample to delivery of our first customer sample. Ramp to a million units would take another seven or eight months. By contrast, today, the time from engineering sample to shipping a million units happens in less than six months.”

—LEADING RF CHIPMAKER

RF FRONT-END COMPLEXITY

500,000X

Increase

TIME-TO-MARKET DEMANDS

32

Months



6

Months

Compounding and conflicting issues pressure the product development lifecycle

Product Lifecycle



57%

of respondents fear their production processes are outdated and cannot keep up with new business and technology trends

46%

say they will lose market share within 2 years unless they make significant changes to product lifecycle processes



What about Test and Measurement?





T&M did not keep up with the Rate of Change



ni An Example of Rate of Change: History of the Camera



1930s

1970s

1990s

2000s

2020+

First CMOS imaging sensor (1985)

Camera meets Cell Phone (1997)

Capturing Memories

Home security

Car backup cameras

Wireless picture exchange

Video conferencing

Video doorbells

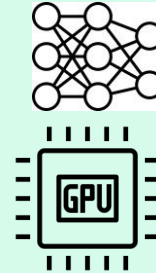
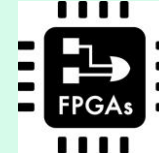
Augmented reality

History of Analogue Electronics Measurement Equipment

Box Instruments



Signal Sources Noise Figure Meter Vector Signal Generators
Power Meters Phase Noise Analyzers Vector Signal Analyzers
Spectrum Analyzers
Oscilloscopes Vector Network Analyzers



AI/ML

?

Modular Instruments



1930s

Nyquist Theorem (1924)

1970s

First CMOS Flash ADC (1979)

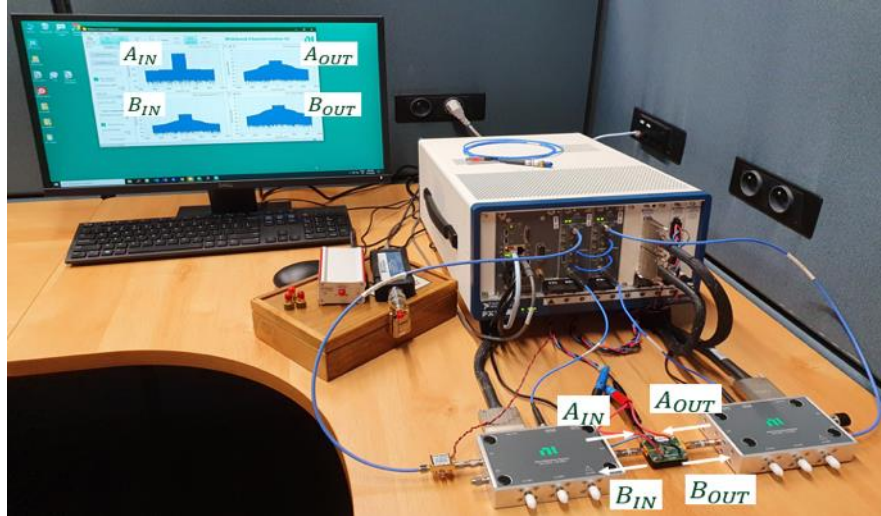
1990s

2000s

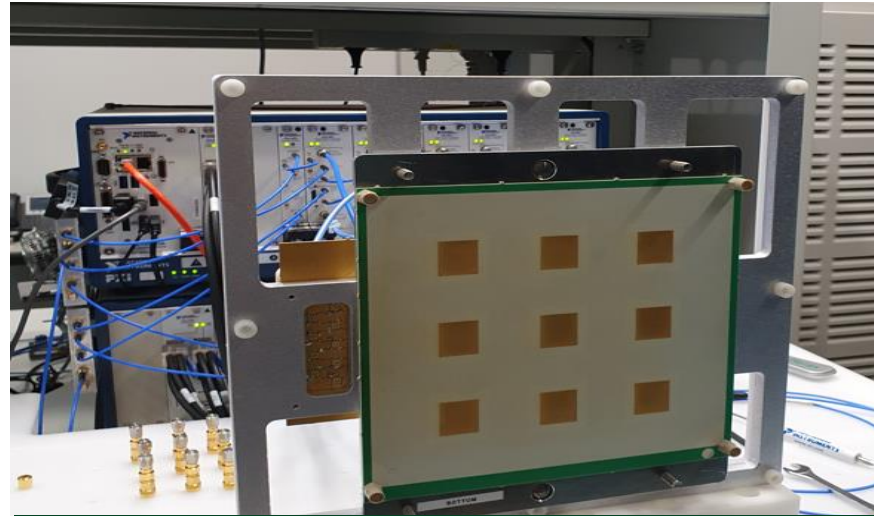
2020+



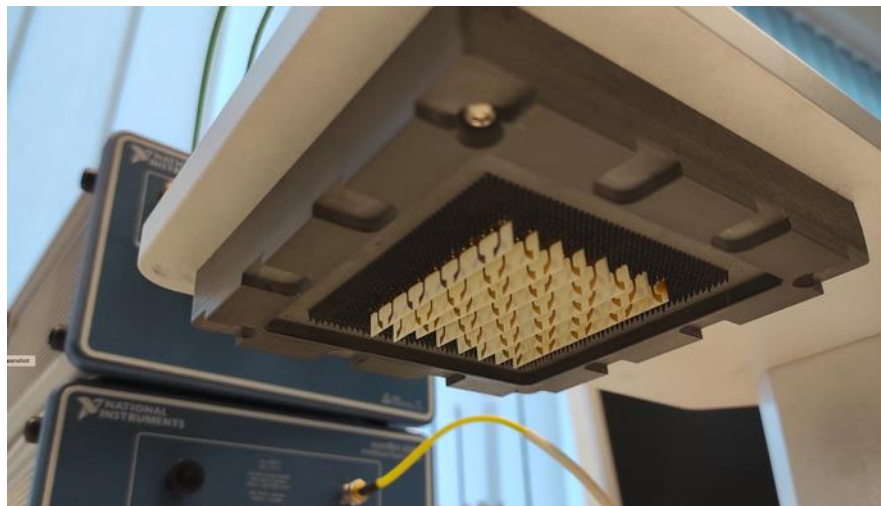
Measurement Hardware Will Evolve



Improved measurement accuracy



Channel / Port Count



Over the Air Characterization



Massive-scale system emulation

Higher Frequency and
Larger Bandwidths (closer
to the DUT)

Scalability in Channels
(smaller and lower cost)

Higher Performance
Measurements

Real-time processing (HIL)

System Level
Measurements

Efficiency of Cloud and
Edge Processing

Blend of Virtual & Physical
Testing

ni Improved Measurement Accuracy under Realistic Conditions

- Spectrum Analyzer
- Oscilloscopes
- Vector Signal Analyzers

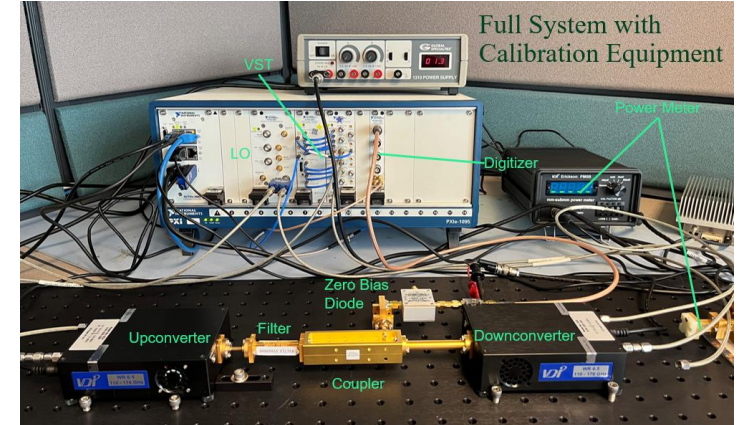
Signal Analysis

In many cases
Nonlinear behavior

- Vector Network Analyzers

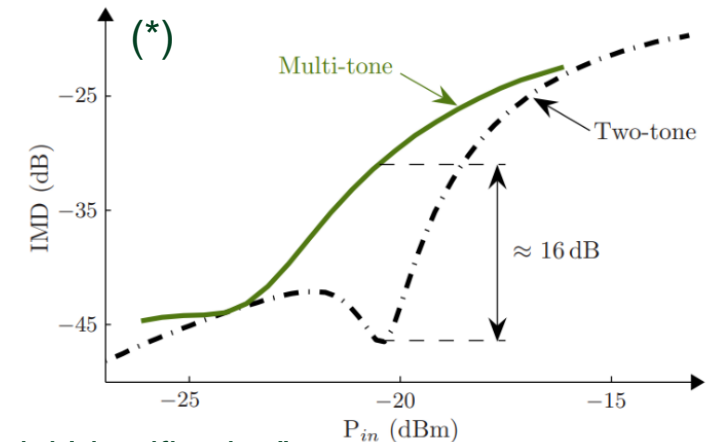
DUT Analysis

BUT
Limited to Linear Devices
[S-parameters]

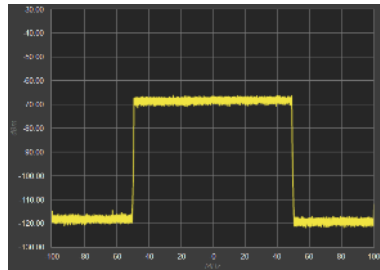


Higher frequencies
Larger instantaneous bandwidth

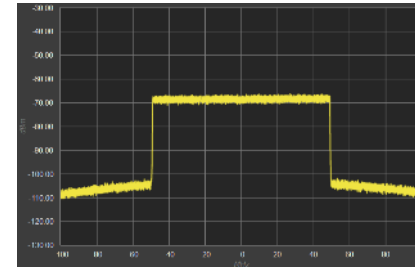
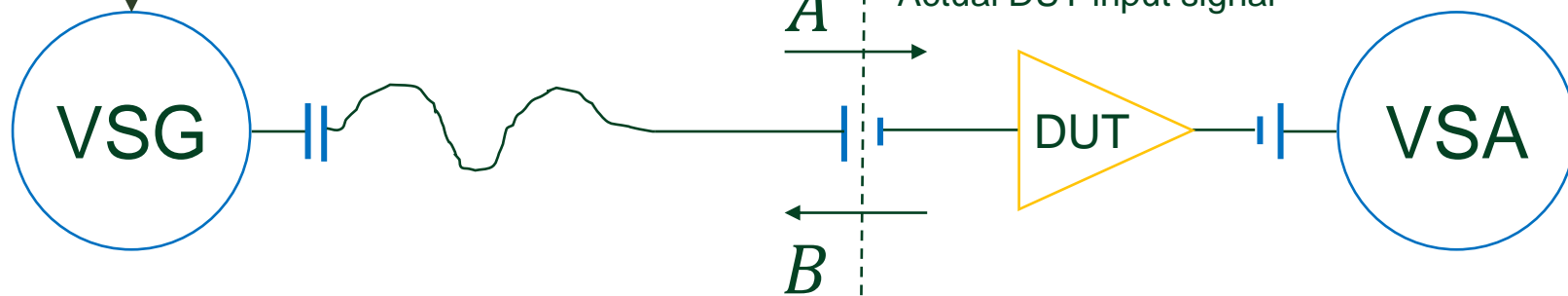
- Path distortion
- Impedance mismatch
- Realistic signals



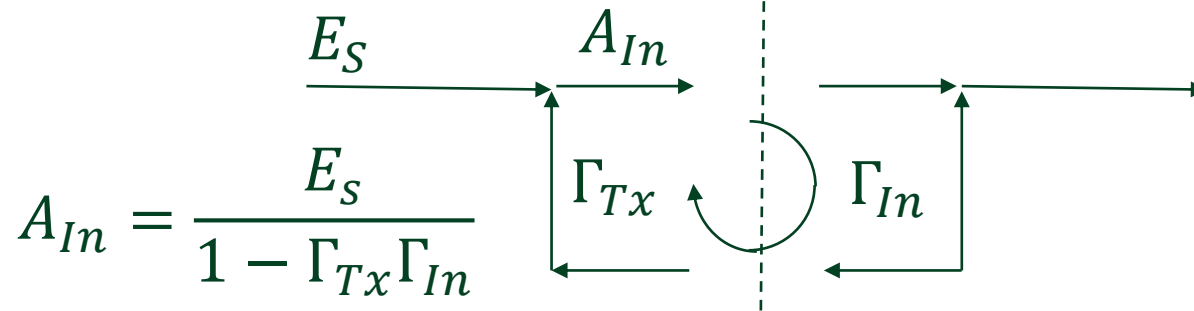
ni Improved Measurement Accuracy – VSG and VSA Setup



Reference Signal



Actual DUT input signal



- Linear and Nonlinear
- Path distortion
 - Mismatch distortion

Improved Measurement Accuracy – Ampl / Phase Uncertainty A_1

Lower limit

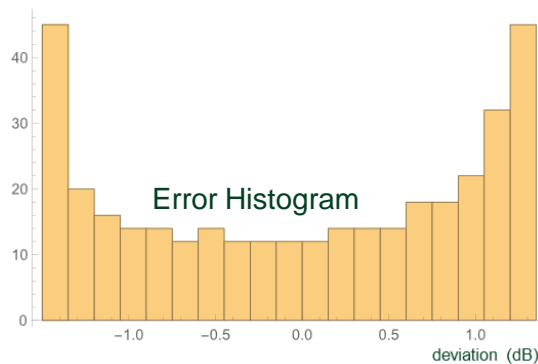
Amplitude

Γ_S							
-25	-0.0275	-0.0490	-0.0873	-0.124	-0.156	-0.197	-0.248
-20	-0.0490	-0.0873	-0.156	-0.221	-0.279	-0.353	-0.447
-15	-0.0873	-0.156	-0.279	-0.397	-0.503	-0.638	-0.811
-12	-0.124	-0.221	-0.397	-0.566	-0.719	-0.915	-1.17
-10	-0.156	-0.279	-0.503	-0.719	-0.915	-1.17	-1.50
-8	-0.197	-0.353	-0.638	-0.915	-1.17	-1.50	-1.93
-6	-0.248	-0.447	-0.811	-1.17	-1.50	-1.93	-2.51
Γ_L	-25	-20	-15	-12	-10	-8	-6

Upper limit

Γ_S							
-25	0.0274	0.0487	0.0864	0.122	0.153	0.192	0.241
-20	0.0487	0.0864	0.153	0.215	0.270	0.339	0.425
-15	0.0864	0.153	0.270	0.380	0.475	0.594	0.742
-12	0.122	0.215	0.380	0.531	0.664	0.828	1.03
-10	0.153	0.270	0.475	0.664	0.828	1.03	1.28
-8	0.192	0.339	0.594	0.828	1.03	1.28	1.58
-6	0.241	0.425	0.742	1.03	1.28	1.58	1.95
Γ_L	-25	-20	-15	-12	-10	-8	-6

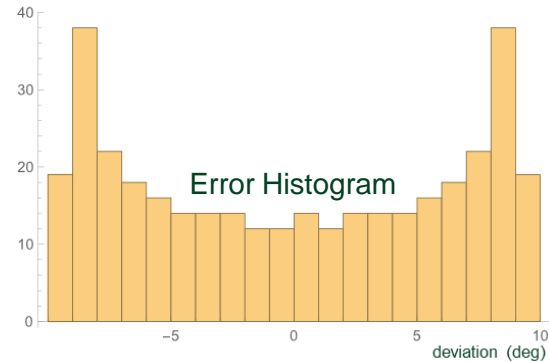
hits (out of 360)



Phase

Γ_S							
-25	0.181	0.322	0.573	0.809	1.02	1.28	1.61
-20	0.322	0.573	1.02	1.44	1.81	2.28	2.87
-15	0.573	1.02	1.81	2.56	3.22	4.06	5.11
-12	0.809	1.44	2.56	3.62	4.56	5.74	7.23
-10	1.02	1.81	3.22	4.56	5.74	7.23	9.12
-8	1.28	2.28	4.06	5.74	7.23	9.12	11.5
-6	1.61	2.87	5.11	7.23	9.12	11.5	14.5
Γ_L	-25	-20	-15	-12	-10	-8	-6

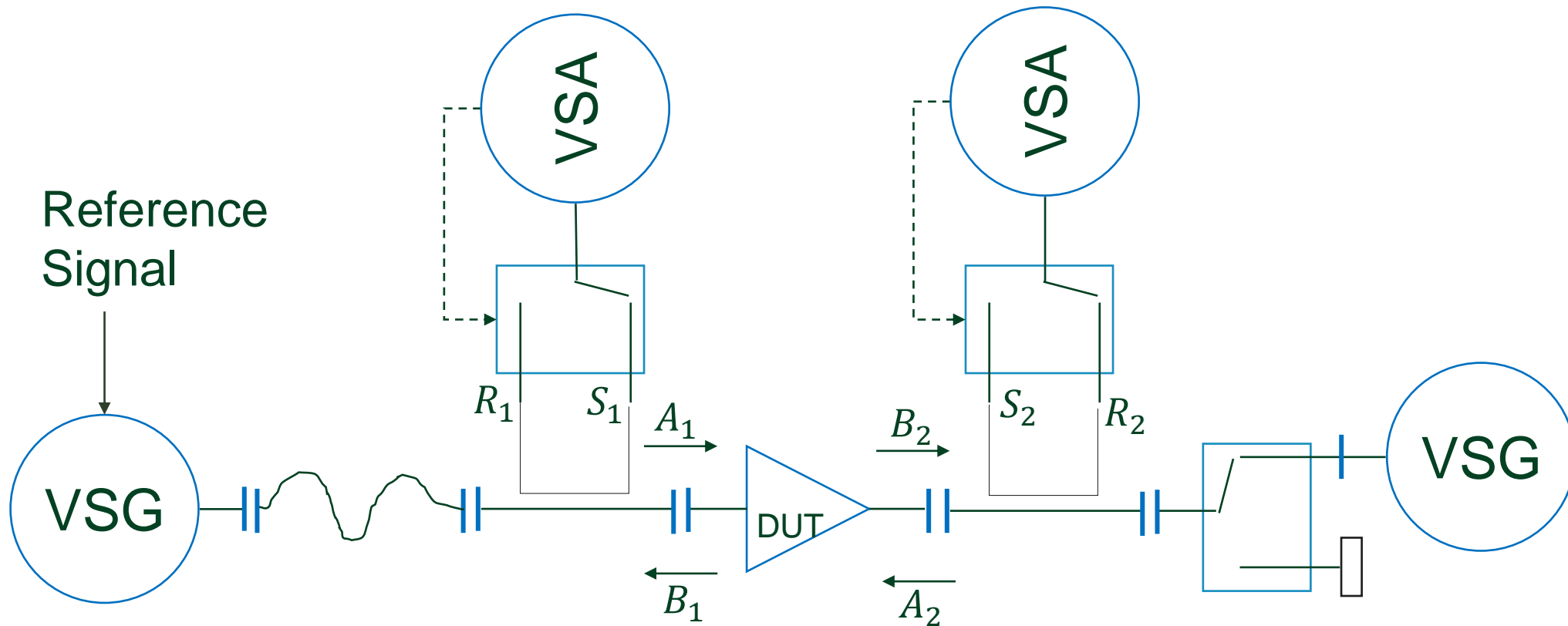
hits (out of 360)



For -10/-6 dB mismatch combination

- -1.5 .. +1.3 dB
- -9.1 .. +9.1 deg

ni Convergence of Instrumentation for Improved Measurement Accuracy (I)



ni Convergence of Instrumentation for Improved Measurement Accuracy (II)

Measured Quantities: R, S

Quantities at DUT Input Plane: A, B

Vector error correction model in wave formalism:

$$\begin{pmatrix} A \\ B \end{pmatrix} = K \begin{bmatrix} 1 & \beta \\ \gamma & \delta \end{bmatrix} \cdot \begin{pmatrix} R \\ S \end{pmatrix} = \underbrace{K}_{\text{Signal Analysis}} \underbrace{M}_{\text{DUT Analysis}} \cdot \begin{pmatrix} R \\ S \end{pmatrix}$$

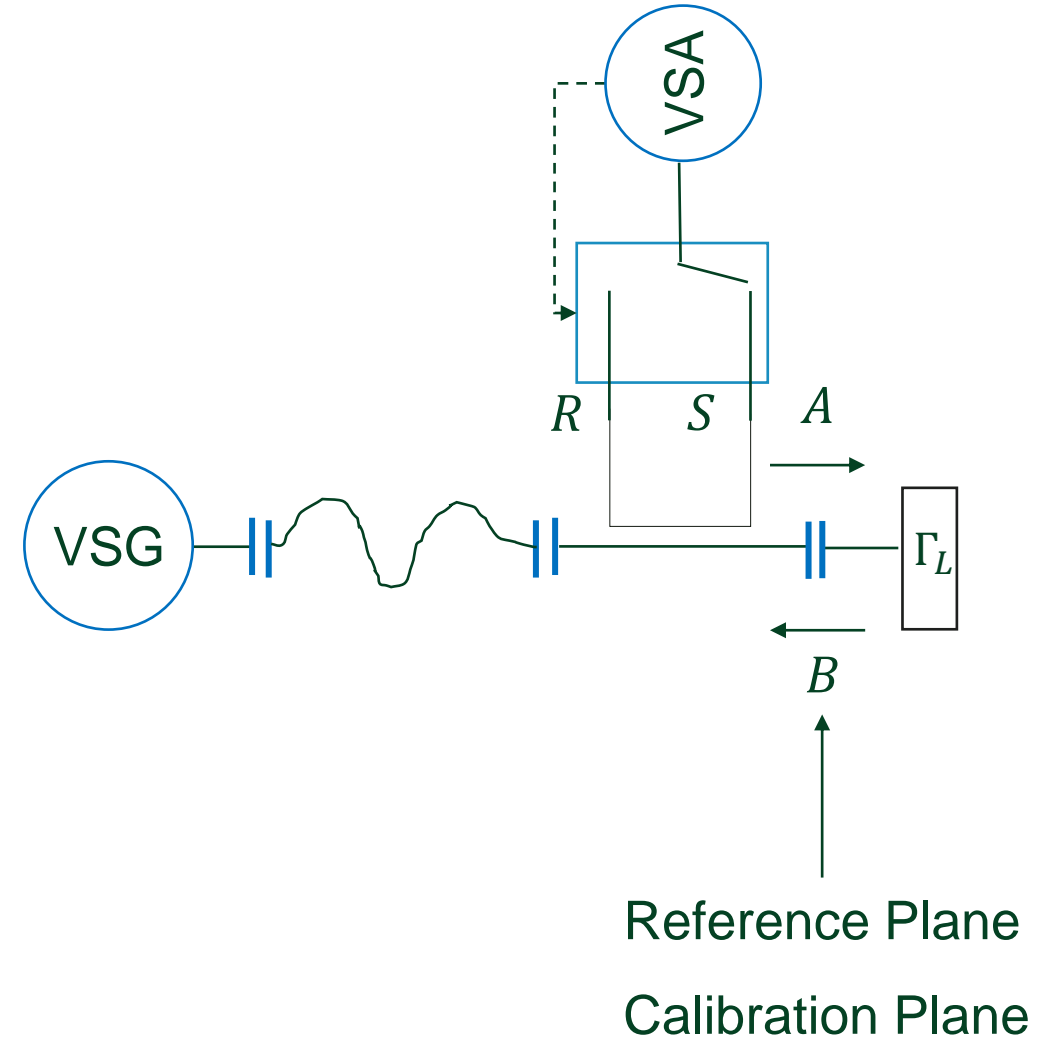
M ... relative error coefficients

$|K|$... absolute power scaling

$\arg(K)$... absolute phase

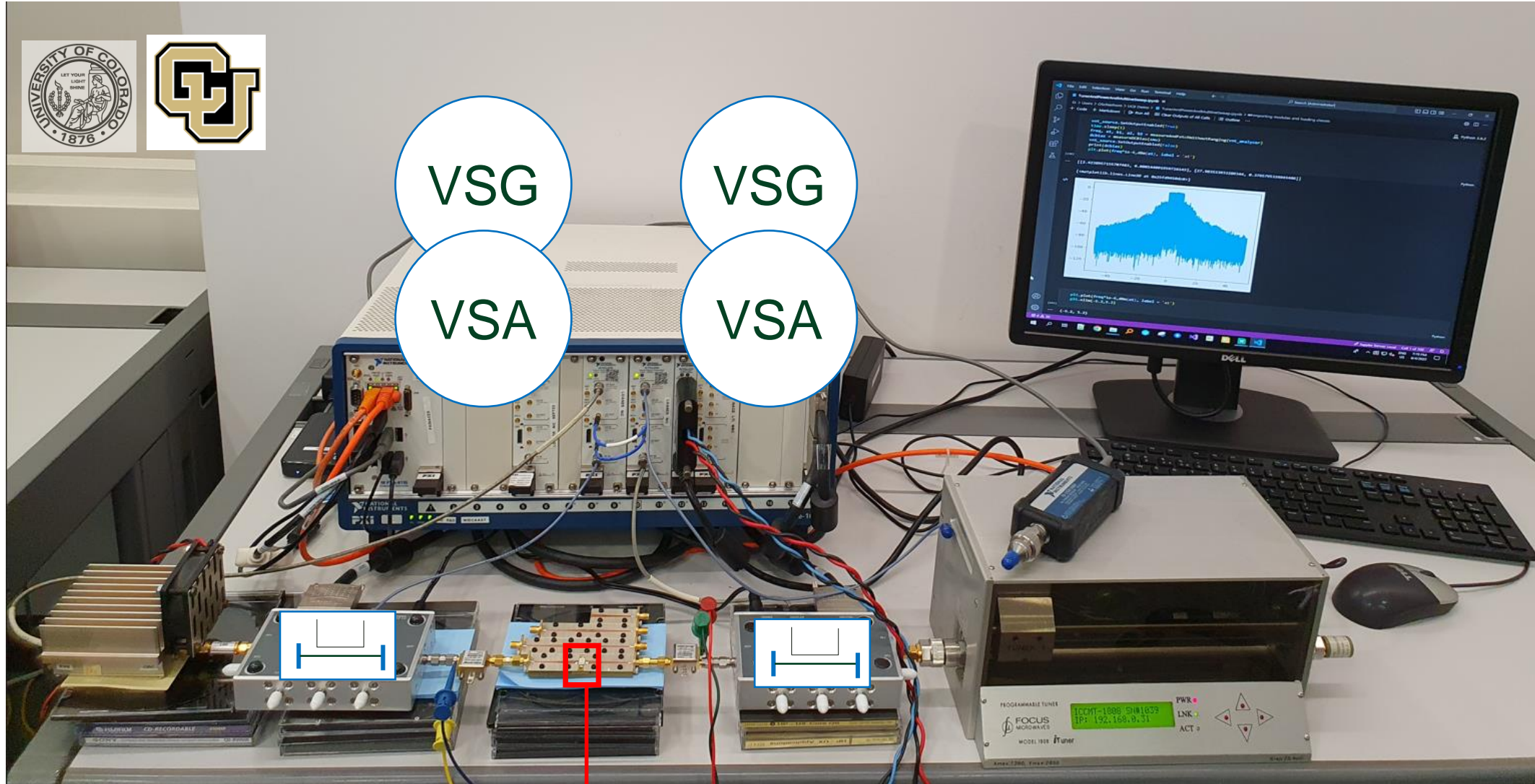


Comb generator



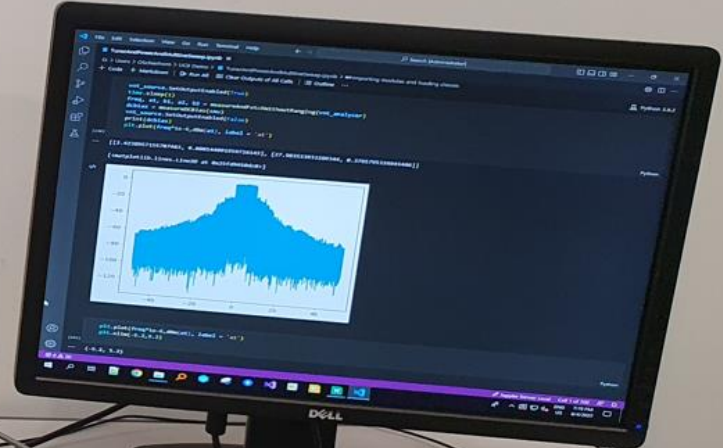
Remark: Measurement of Γ_L does not need a K factor.

ni Improved Measurement Accuracy for a Two-Port Setup – In Fixture



VSG
VSA

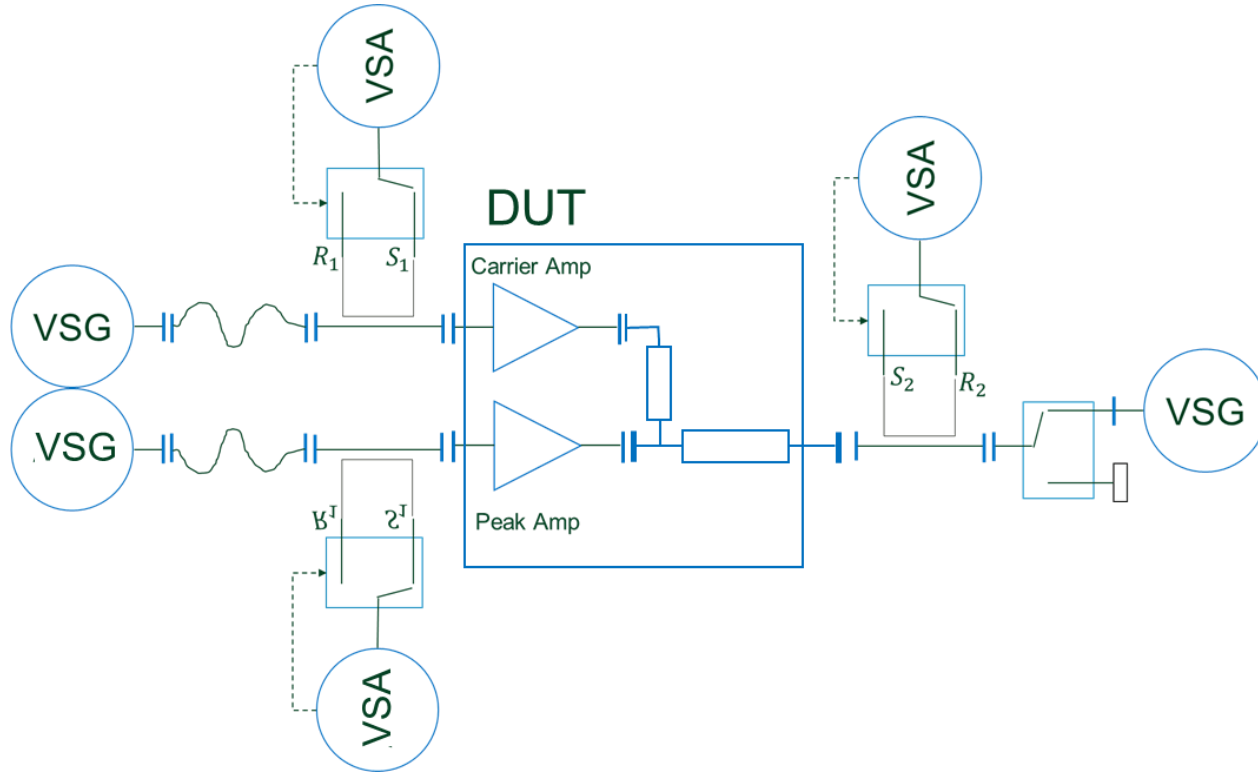
VSG
VSA



CGH40006P 6 W, RF Power GaN HEMT

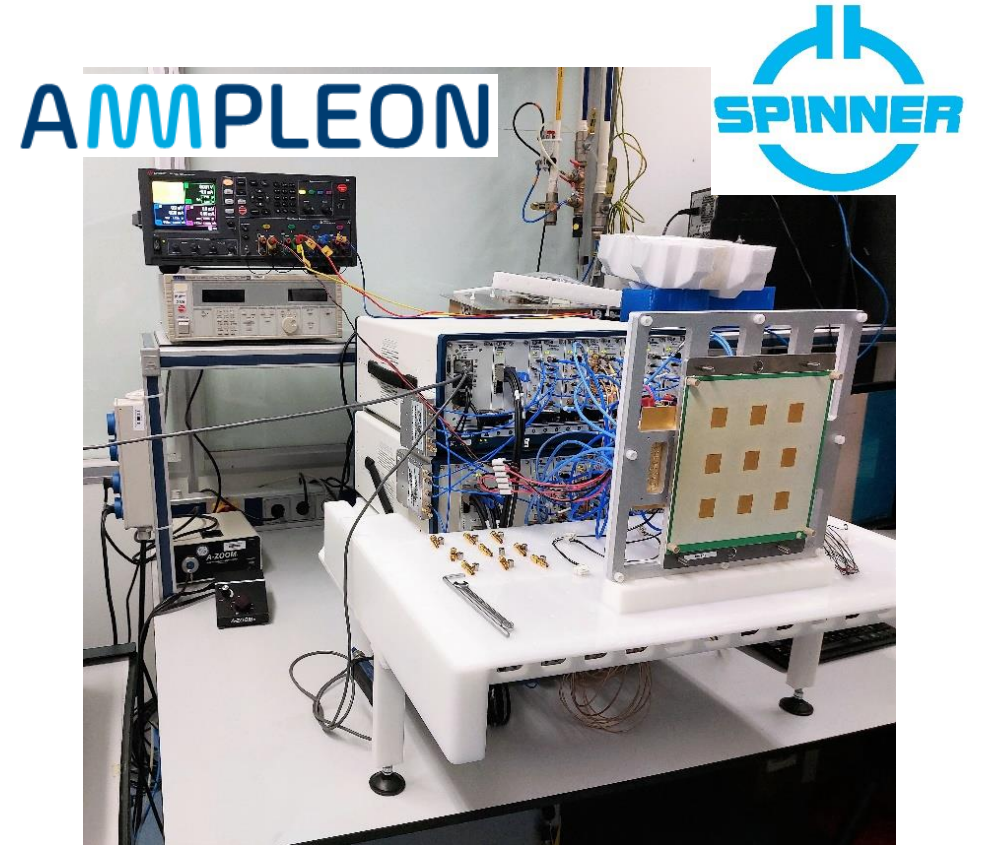
ni Channel / Port Scalability

3-port



Doherty Amplifier

9-port



Amplifier Characterization under Beamforming

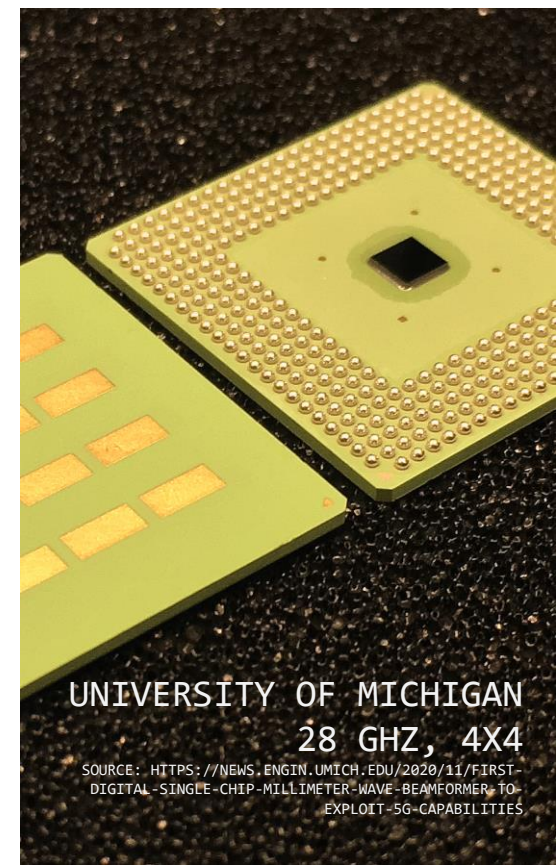
From Conductive to Over the Air Characterization

mmWave active antenna arrays are being deployed already for 5G

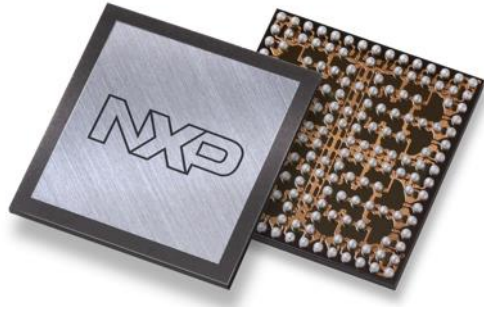
Combined use of analog and digital beamforming

Trend towards highly integrated designs

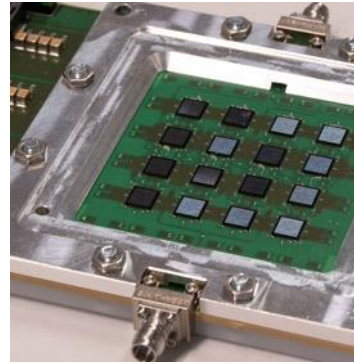
- Antenna in package (AiP)
- Antenna on chip (AoC)



ni Over the Air Characterization



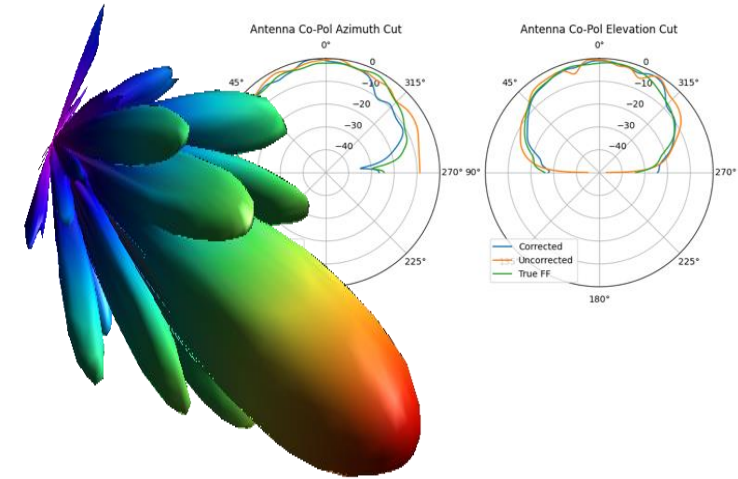
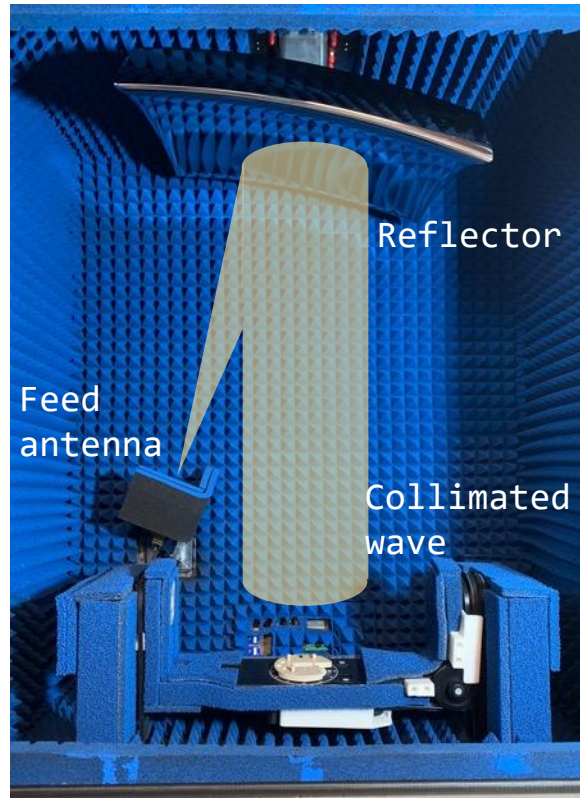
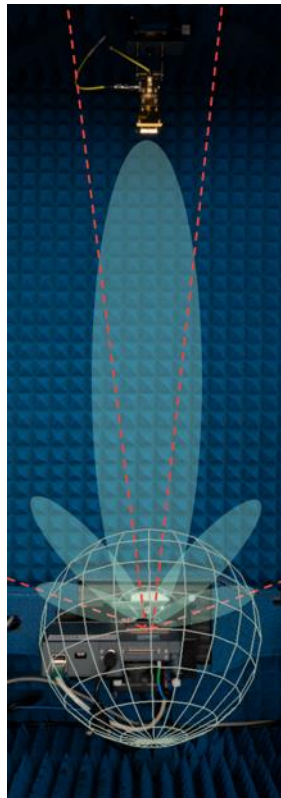
NXP MMW9014K beamformer



NXP 8x8 dual-pol antenna panel



Antenna side

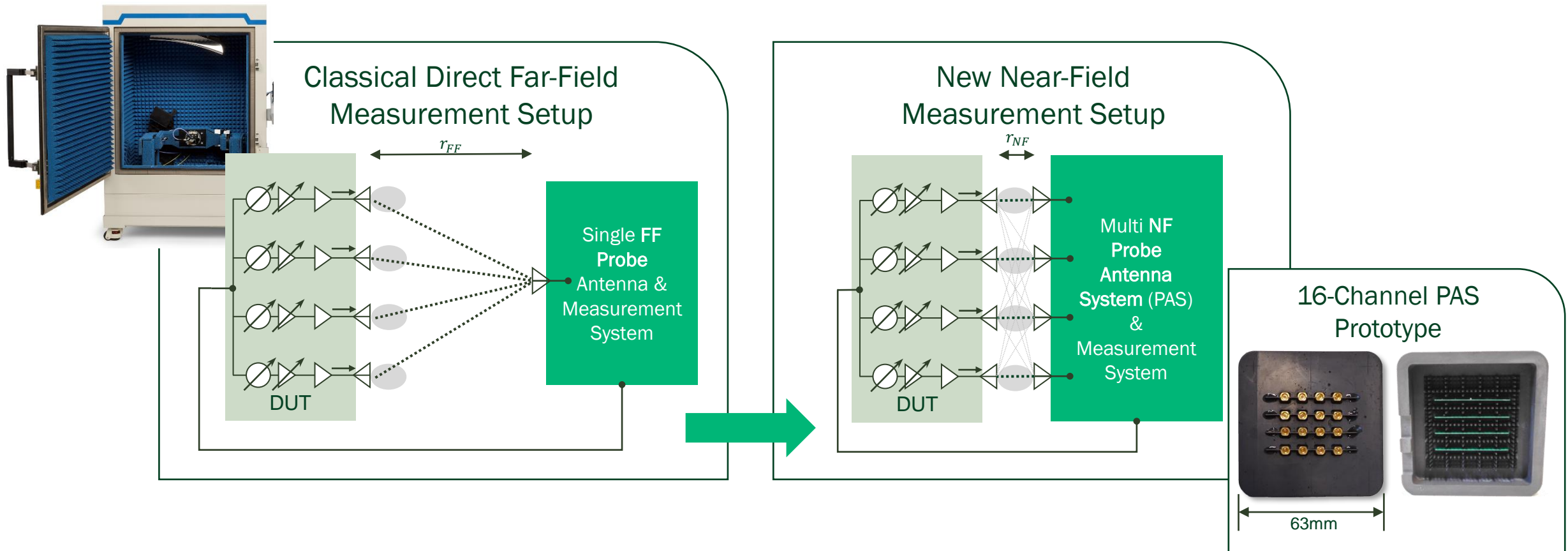


- HF Electrical Measurements
- and Accurate Mechanical Positioning
- What does one need to measure ?
- New calibration techniques

ni Evolve Instruments to reduce Cost of Production Test

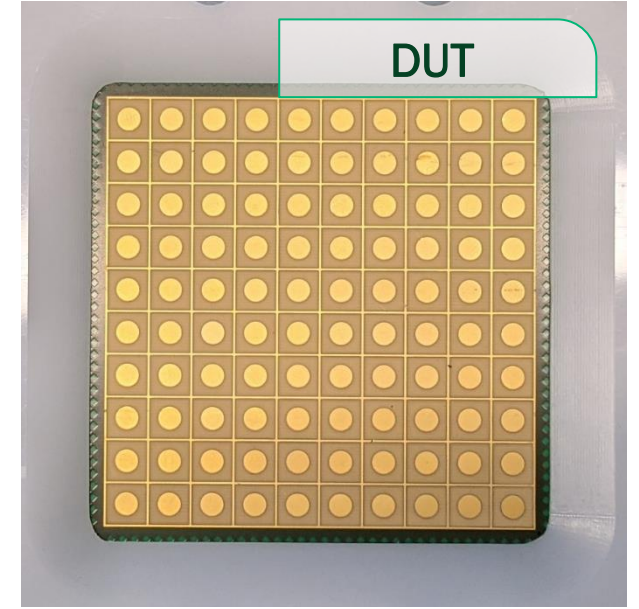
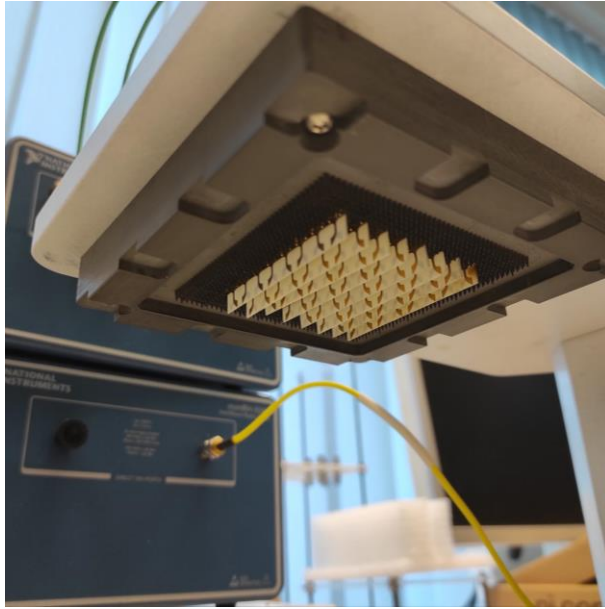
Example

Near-Field Probe Antenna System (PAS)



ni The Near-Field Probe Antenna System

PAS



Reconstruction of the DUT far-field behavior with a static appliance

ni The Near-Field Probe Antenna System

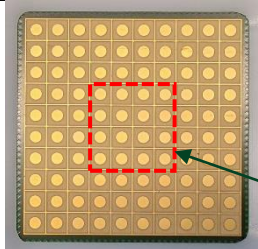
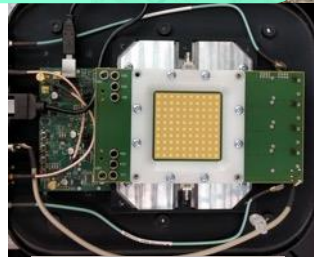


NI mmWave Measurement Instrument

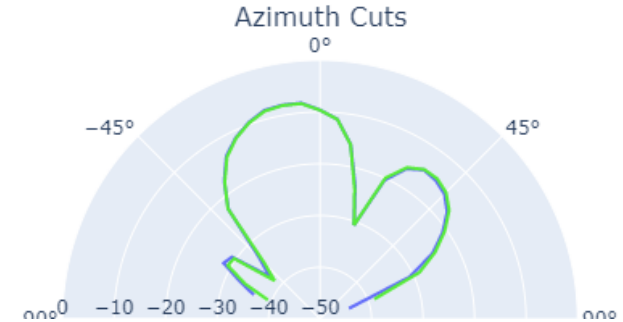
16-Channel Near-field Probe (PAS)

8x8 Channel DUT
24.25 – 27.5 GHz

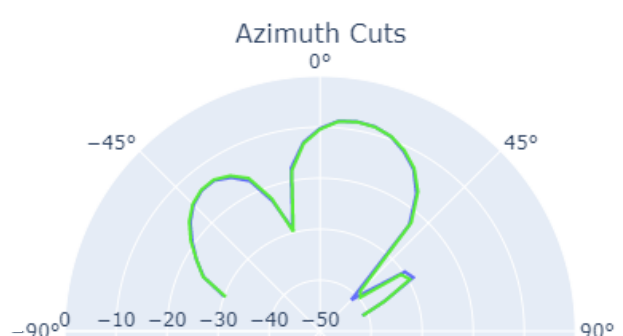
Distance between PAS and DUT ~3mm



4x4 inner elements used for proof-of-concept only



Beam #1



Beam #2

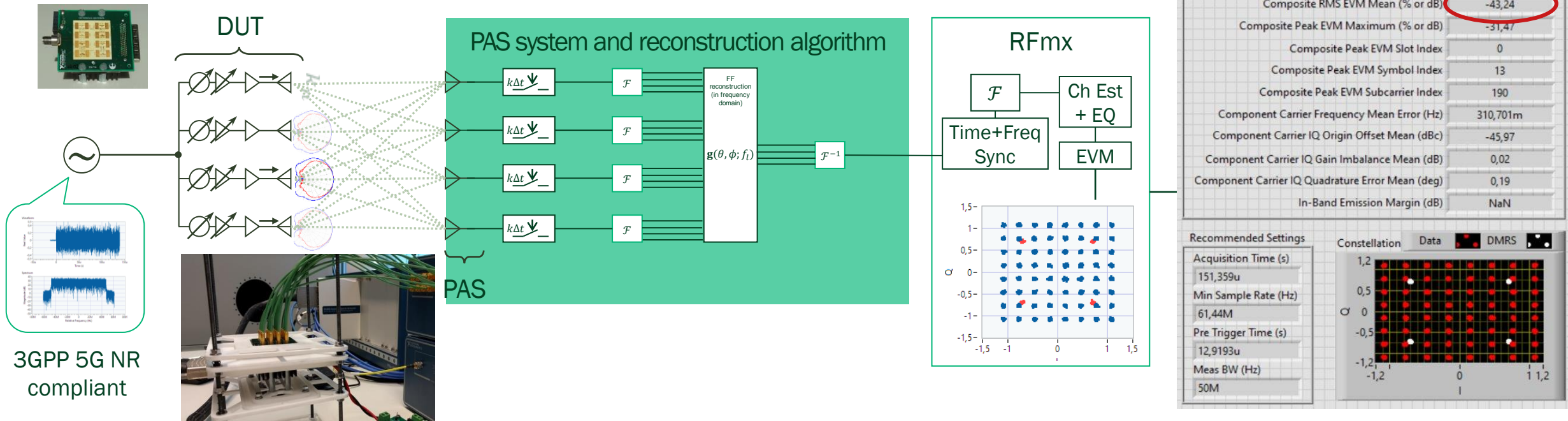
- Reconstructed from near-field measurements
- Reference far-field measurement

Measurements at 26 GHz

ni The Near-Field Probe Antenna System

Extension to broadband operation enables modulated measurements

- Multi-tone calibration and frequency-sliced reconstruction yield far field under modulation conditions
- **NF PAS has better measurement sensitivity** compared to an OTA chamber-based approach because we minimize pathloss that occurs in chamber

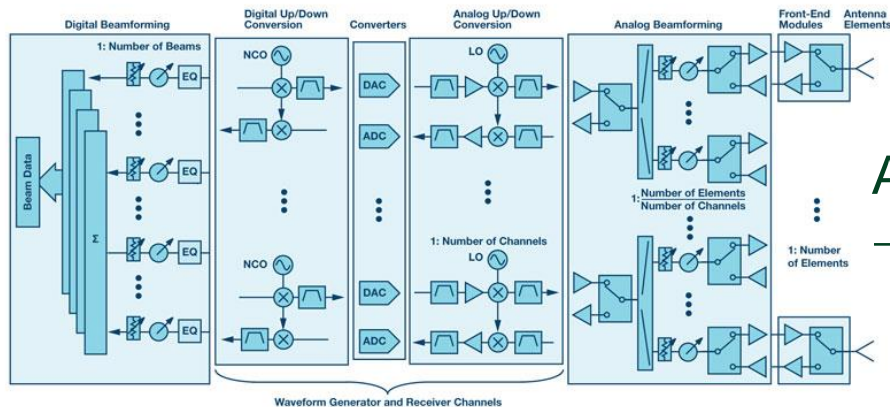


ni T&M and AI/ML

Temperature

Reflections

Many different hardware states



Antenna's
→ beamforming

Sensors
Actuators
[Digital]

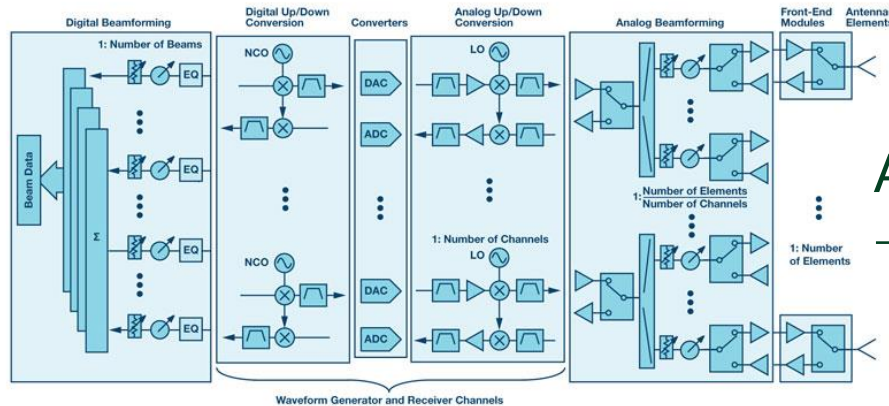
Sensors
Actuators
[Analogue]

- Very deterministic
 - Complex / Many tests
- ↓
- Physical insight
 - Model
 - E.g. Adaptive sampling
- = more efficient than AI / ML

ni T&M and AI/ML

Real Environment (many combinations of temperature and reflections)

Many different hardware states



Antenna's
→ beamforming

“Intelligence”

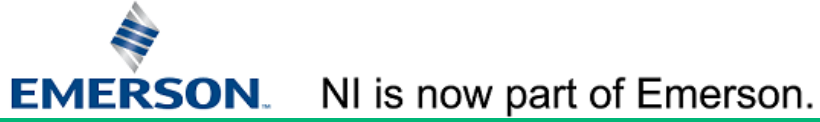


Learning as
“it” evolves

Sensors
Actuators
[Digital]

Sensors
Actuators
[Analogue]

- Very dynamic
- Complex
- Lack of Physical insight
- Scenario testing
- No guarantees anymore
- “DUT needs to pass exam”
- “To create / adapt the exam, use AI/ML in T&M”



Questions ...

The evolution of Wireless Communication is shaking up Test And Measurement!

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